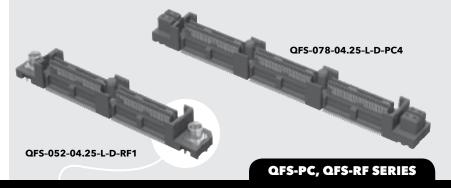




(0.635 mm) .025"



HIGH-SPEED COMBO RF & POWER

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?QFS

Insulator Material: Liquid Crystal Polymer Contact & Ground Plane Material: Phosphor Bronze Plating: Au over 50 μ" (1.27 μm) Ni (Tin on Ground Plane Tail) **Current Rating:** Signal Contact: 2.6 A per pin (2 pins powered) Power Contact: 4.0 A per pin (4 pins powered per end) Ground Plane: 15.7 A per ground plane (1 ground plane powered)

Voltage Rating:
300 VAC mated with QMS Operating Temp: -55 °C to +125 °C

PROCESSING

Lead-Free Solderable:

RoHS Compliant:

SMT Lead Coplanarity: Goldon (0.10 mm) .004" max (026-078) Board Stacking:
For applications requiring more than two connectors per board, contact ipg@samtec.com

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



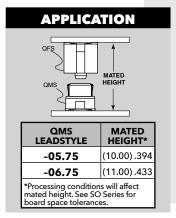
ALSO AVAILABLE (MOQ Required)

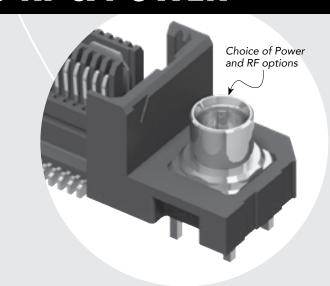
- Other platings
- Differential Pairs
- Retention Pins
- 8 Power Pins/End for (1.60 mm) .062" thick board
- 4 or 8 Power Pins/End for (2.36 mm) .093" thick board
- 2 RF Connectors/End
- Hot Pluggable

Some lengths, styles and options are non-standard, non-returnable.

Board Mates:

QMS-PC, QMS-RA-PC, QMS-RF



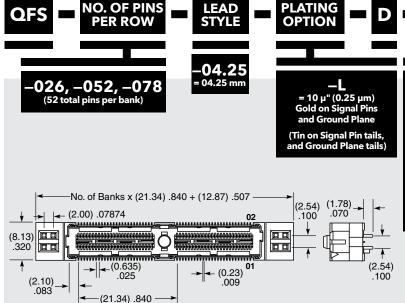


(1.78)

.070

(3.56) (0.70) (3.56) (0.70)

.140 DIA



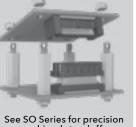
-PC4 OPTION

No. of Banks x (21.34) .840 + (14.30) .563

-RF1 OPTION

OPTION PC4 -TR =Tape & Reel = 4 Power Pins per End for (1.60 mm) .062" thick Board (Not available -FR = Full Reel Tape & Reel with -RF1) (must order max quantity per reel; contact Samtec -RF1 for quantity = One RF breaks) Jack per End (Not available with -PC4)





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ASP-129646-03 ASP-129646-01